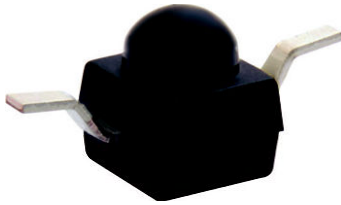




## Silicon NPN Phototransistor



VENT2003X01



VENT2023X01

### DESCRIPTION

VENT2003X01 series are silicon NPN epitaxial planar phototransistors with daylight blocking filter in a miniature, black dome lens package for surface mounting. Filter bandwidth is matched with 830 nm to 950 nm IR emitters.

### FEATURES

- Package type: surface mount
- Package form: GW, RGW
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- AEC-Q101 qualified
- High radiant sensitivity
- Daylight blocking filter matched with 830 nm to 950 nm IR emitters
- Fast response times
- Angle of half sensitivity:  $\phi = \pm 35^\circ$
- Package matched with IR emitter series VSMB2943RGX01 and VSMB2943GX01
- Floor life: 4 weeks, MSL 2a, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



### APPLICATIONS

- Detector in automotive applications
- Photo interrupters
- Miniature switches
- Counters
- Encoders
- Position sensors

| PRODUCT SUMMARY |                      |              |                      |
|-----------------|----------------------|--------------|----------------------|
| COMPONENT       | I <sub>ca</sub> (mA) | $\phi$ (deg) | $\lambda_{0.5}$ (nm) |
| VENT2003X01     | 2.7                  | $\pm 35$     | 790 to 970           |
| VENT2023X01     | 2.7                  | $\pm 35$     | 790 to 970           |

#### Note

- Test condition see table "Basic Characteristics"

| ORDERING INFORMATION |               |                              |                  |
|----------------------|---------------|------------------------------|------------------|
| ORDERING CODE        | PACKAGING     | REMARKS                      | PACKAGE FORM     |
| VENT2003X01          | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Reverse gullwing |
| VENT2023X01          | Tape and reel | MOQ: 6000 pcs, 6000 pcs/reel | Gullwing         |

#### Note

- MOQ: minimum order quantity



| <b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |   |            |               |                    |
|--|---|------------|---------------|--------------------|
| PARAMETER  | TEST CONDITION                            | SYMBOL     | VALUE         | UNIT               |
| Collector emitter voltage  |   | $V_{CEO}$  | 20            | V                  |
| Emitter collector voltage  |   | $V_{ECO}$  | 7             | V                  |
| Collector current  |   | $I_C$      | 50            | mA                 |
| Power power dissipation  | $T_{amb} \leq 75\text{ }^{\circ}\text{C}$ | $P_V$      | 100           | mW                 |
| Junction temperature   |   | $T_j$      | 100           | $^{\circ}\text{C}$ |
| Operating temperature range  |   | $T_{amb}$  | - 40 to + 100 | $^{\circ}\text{C}$ |
| Storage temperature range  |   | $T_{stg}$  | - 40 to + 100 | $^{\circ}\text{C}$ |
| Soldering temperature  | Acc. reflow profile fig. 8                | $T_{sd}$   | 260           | $^{\circ}\text{C}$ |
| Thermal resistance junction/ambient  | Acc. J-STD-051                            | $R_{thJA}$ | 250           | K/W                |



Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

| <b>BASIC CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified) |  |                 |      |            |      |      |
|---|--|-----------------|------|------------|------|------|
| PARAMETER   | TEST CONDITION   | SYMBOL          | MIN. | TYP.       | MAX. | UNIT |
| Collector emitter breakdown voltage   | $I_C = 0.1\text{ mA}$  | $V_{CEO}$       | 20   |            |      | V    |
| Collector dark current  | $V_{CE} = 5\text{ V}, E = 0$   | $I_{CEO}$       |      | 1          | 100  | nA   |
| Collector emitter capacitance   | $V_{CE} = 0\text{ V}, f = 1\text{ MHz}, E = 0$                         | $C_{CEO}$       |      | 25         |      | pF   |
| Collector light current   | $E_e = 1\text{ mW/cm}^2, \lambda = 950\text{ nm}, V_{CE} = 5\text{ V}$ | $I_{ca}$        | 1.3  | 2.7        | 4.1  | mA   |
| Angle of half sensitivity   |  | $\phi$          |      | $\pm 35$   |      | deg  |
| Wavelength of peak sensitivity  |  | $\lambda_p$     |      | 860        |      | nm   |
| Range of spectral bandwidth   |  | $\lambda_{0.5}$ |      | 790 to 970 |      | nm   |
| Collector emitter saturation voltage  | $I_C = 0.05\text{ mA}$   | $V_{CEsat}$     |      |            | 0.4  | V    |
| Temperature coefficient of $I_{ca}$   | $E_e = 1\text{ mW/cm}^2, \lambda = 950\text{ nm}, V_{CE} = 5\text{ V}$ | $Tk_{Ica}$      |      | 1.1        |      | %/K  |

**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)



Fig. 2 - Collector Dark Current vs. Ambient Temperature



Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

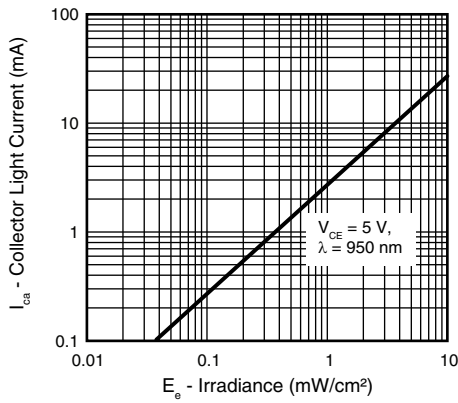


Fig. 3 - Collector Light Current vs. Irradiance

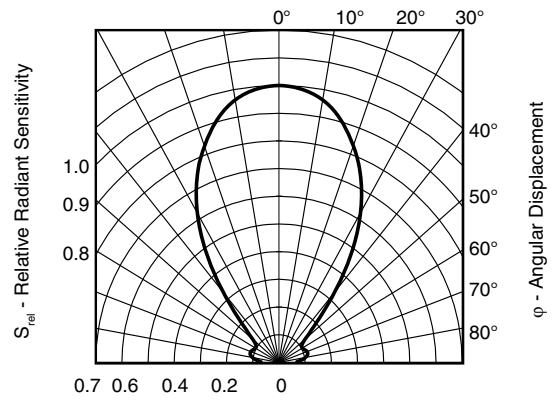


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement



Fig. 4 - Rise/Fall Time vs. Collector Current



Fig. 7 - Relative Collector Current vs. Ambient Temperature

## REFLOW SOLDER PROFILE

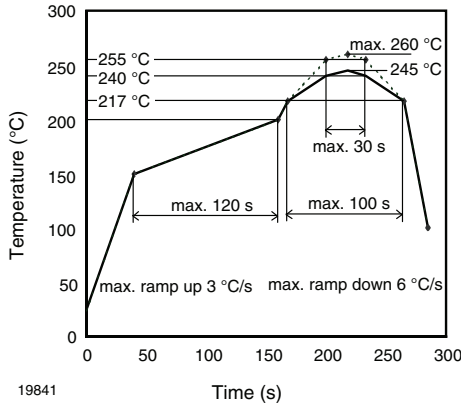


Fig. 8 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

## DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

## FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

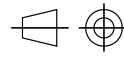
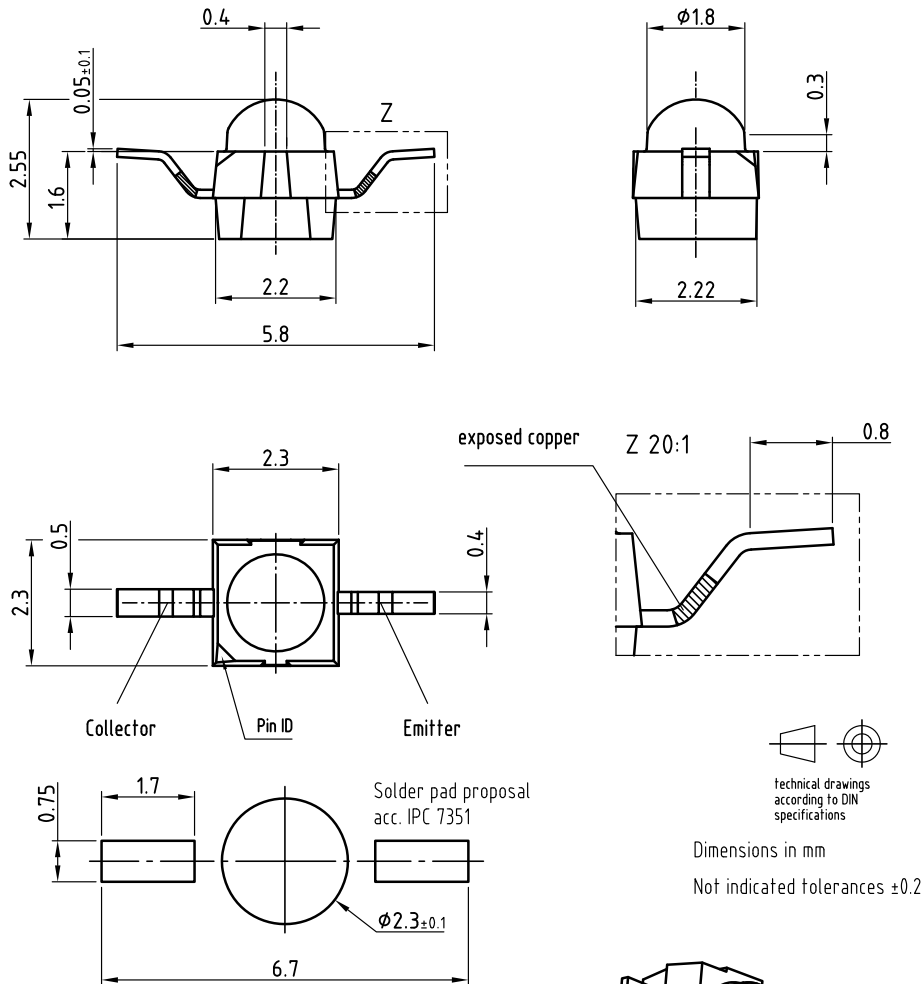
Conditions:  $T_{amb} < 30\text{ }^{\circ}\text{C}$ , RH < 60 %

Moisture sensitivity level 2a, acc. to J-STD-020.

## DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

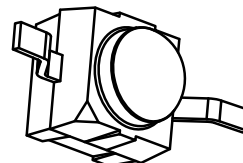
## PACKAGE DIMENSIONS VEMT2003X01 in millimeters



technical drawings according to DIN specifications

Dimensions in mm

Not indicated tolerances ±0.2



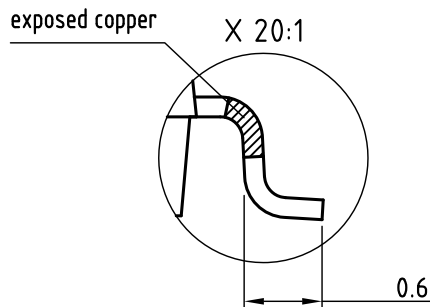
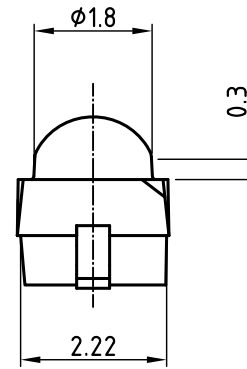
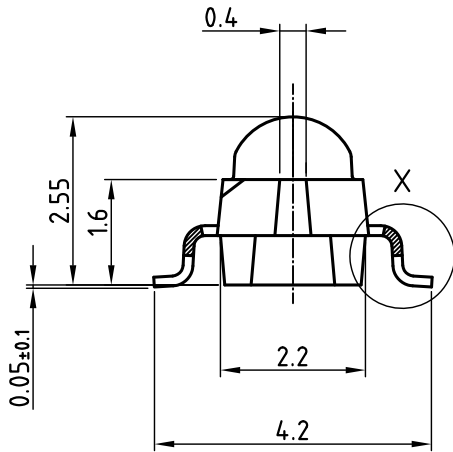
Drawing refers to following types: VEMT2x03X01

Drawing-No.: 6.544-5409.02-4

Issue: prel. 03.08.12



## PACKAGE DIMENSIONS VEMT2023X01 in millimeters



technical drawings according to DIN specifications

Dimensions in mm

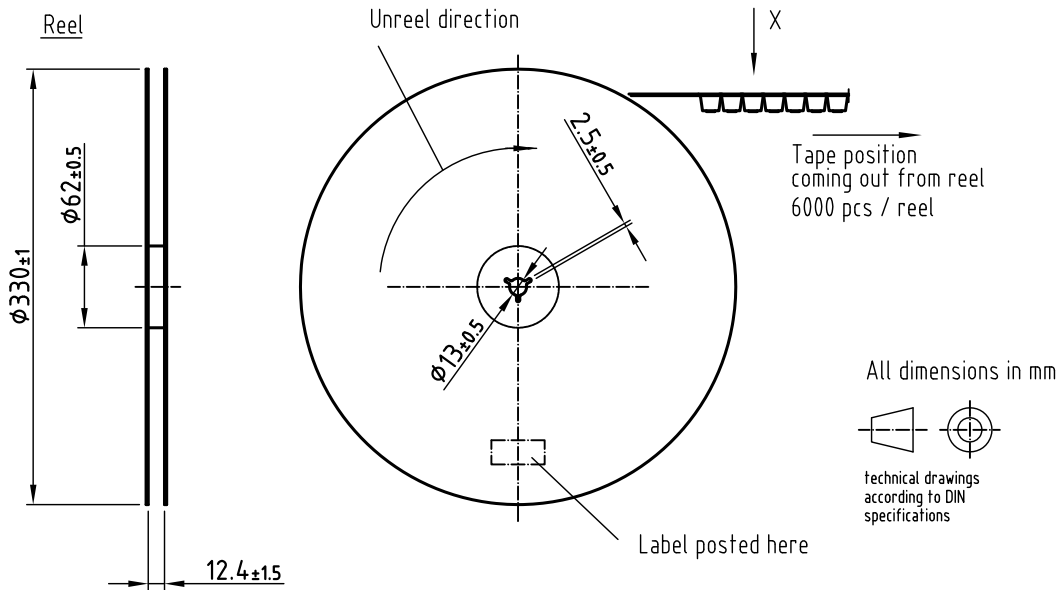
Not indicated tolerances ±0.2

Drawing refers to following types: VEMT2x23X01

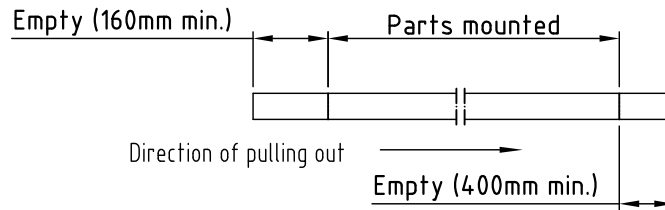
Drawing-No.: 6.544-5408.02-4  
Issue: prel; 03.08.12



## TAPE AND REEL DIMENSIONS VEMT2003X01 in millimeters

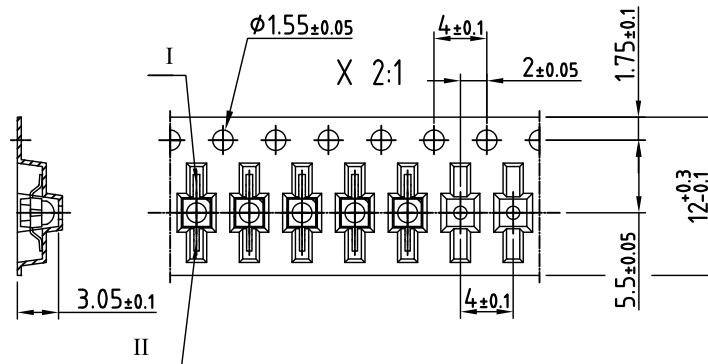


### Leader and trailer tape:



### Terminal position in tape

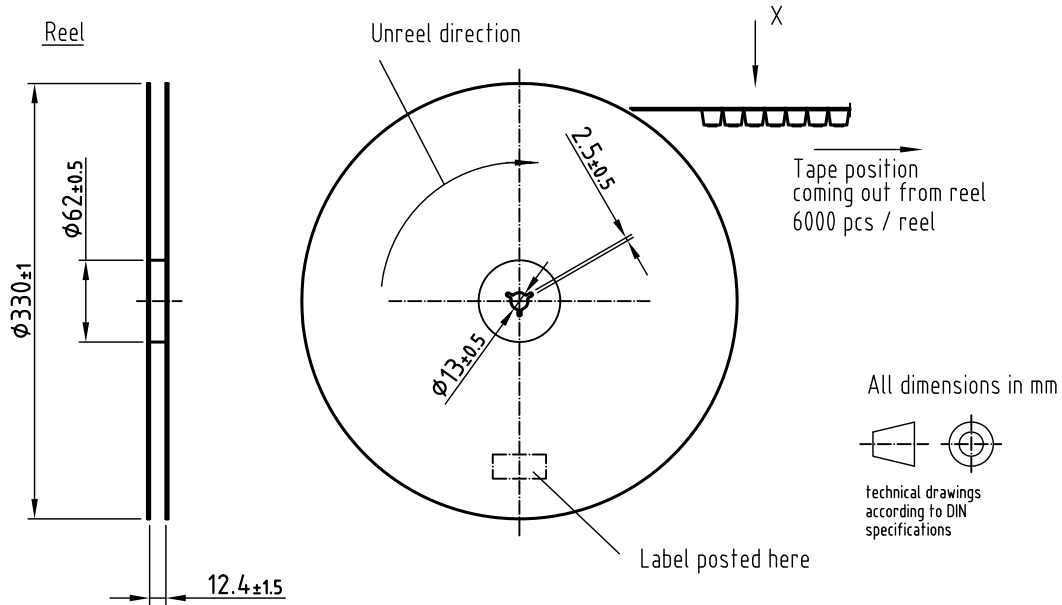
| Device         | Lead I    | Lead II |
|----------------|-----------|---------|
| V SMB2943RGX01 | Cathode   | Anode   |
| V SMF2893RGX01 |           |         |
| VEMD2x03X01    |           |         |
| VEMT2x03X01    | Collector | Emitter |
| VSMY2853RG     | Anode     | Cathode |



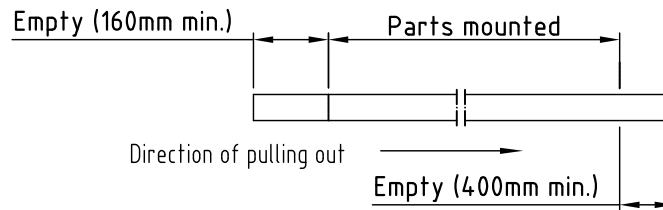
Drawing refers to following types: see table  
Reel dimensions and tape

Drawing-No.: 9.800-5100.02-4  
Issue: prel; 03.08.12

## TAPE AND REEL DIMENSIONS VENT2023X01 in millimeters

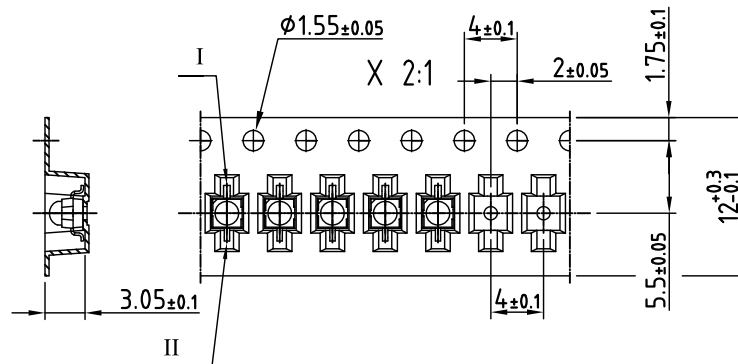


### Leader and trailer tape:



### Terminal position in tape

| Device       | Lead I    | Lead II |
|--------------|-----------|---------|
| VSMB2943GX01 | Cathode   | Anode   |
| VSMF2893GX01 |           |         |
| VEMD2x23X01  |           |         |
| VENT2x23X01  | Collector | Emitter |
| VSMY2853G    | Anode     | Cathode |



Drawing refers to following types: see table  
Reel dimensions and tape

Drawing-No.: 9.800-5091.21-4  
Issue: prel; 03.08.12



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